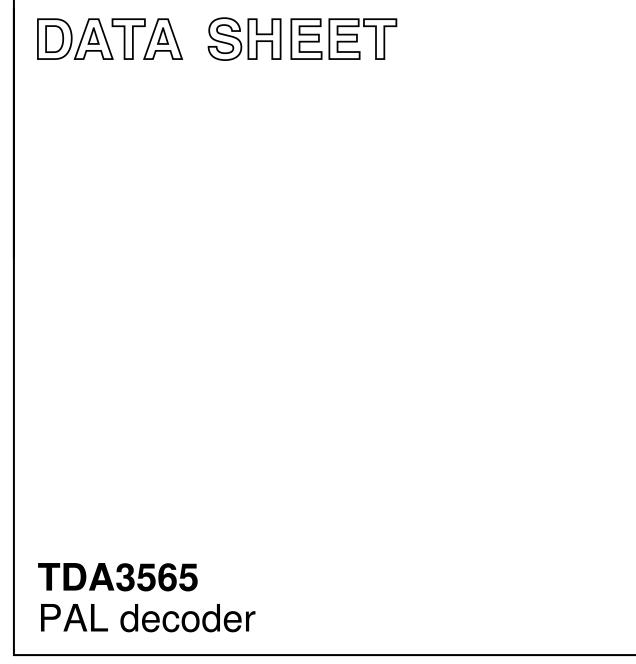
INTEGRATED CIRCUITS



Product specification File under Integrated Circuits, IC02 April 1986



HILIPS

Product specification

TDA3565

GENERAL DESCRIPTION

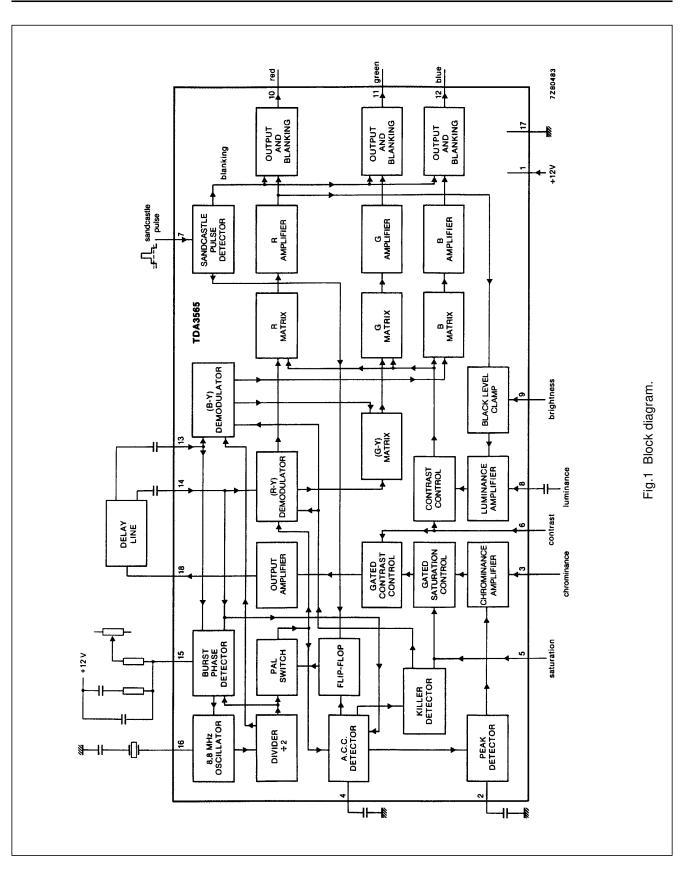
The TDA3565 PAL decoder contains all the functions required for PAL signal decoding and colour matrixing and is contained within an 18-pin package. The oscillator, a.c.c. detector and burst phase detector each have single-pin outputs and the coupling capacitor for the luminance input at pin 8 doubles as a storage capacitor for the black level clamping circuit. Black level clamping of the three colour channels is performed using feedback proportional to the red channel black level. This feedback (variable with the brightness control) controls the input level of the luminance amplifier and therefore the clamping levels of all three colour signal outputs.

QUICK REFERENCE DATA

Supply voltage	$V_{p} = V_{1-17}$	typ.	12	V
Supply current	$I_p = I_1$	typ.	85	mA
Luminance input signal (peak-to-peak value)	V _{8-17(p-p)}	typ.	0,45	V
Chrominance input signal (peak-to-peak value)	V _{3-17(p-p)}	typ.	550	mV
RGB output signal amplitudes (peak-to-peak value)				
at nominal luminance and contrast	V _{10,11,12-17(p-p)}	typ.	5	V
Contrast control range		-1	7 to +3	dB
Saturation control range		>	50	dB
A.C.C. control range		>	30	dB
Level at which RGB blanking is activated	V ₇₋₁₇	typ.	1,5	V
Level at which burst gate/clamping pulse are separated	V ₇₋₁₇	typ.	7	V

PACKAGE OUTLINE

18-lead DIL; plastic (SOT102); SOT102-1; 1996 November 21.



Product specification

TDA3565

Limiting values in accordance with the Absolute Maximum Sys	tem (IEC 134)		
Supply voltage (pin 1)	$V_{P} = V_{1-17}$	max. 13,2	V
Total power dissipation	P _{tot}	max. 1,7	W
Operating ambient temperature range	T _{amb}	-25 to +65	°C
Storage temperature range	T _{stg}	-25 to +150	°C
THERMAL RESISTANCE			
From junction to ambient (in free air)	R _{th j-a}	max. 50	K/W

CHARACTERISTICS

 V_P = $V_{1\text{-}17}$ = 12 V; T_{amb} = 25 $^\circ C$ unless otherwise specified

PARAMETER	SYMBOL	MIN.	TYP.	MAX.	UNIT
Supply (pin 1)					
Supply voltage	V ₁₋₁₇	9,0	12,0	13,2	V
Supply current	I ₁	_	85	_	mA
Total power dissipation	P _{tot}	_	1,0	_	W
Luminance amplifier					
Input signal amplitude (note 2)					
(peak-to-peak value)	V _{8-17(p-p)}	_	0,45	_	V
Input level before clipping occurs (note 1)	V _{8-17(p-p)}	_	-	0,7	V
Input current at $V_{8-17} = 2 V$;					
clamp not active	I ₈	-	0,15	1,0	μA
Contrast control range (Fig.2)		-	-17 to +3	-	dB
Input current when peak white					
limiter is active ($V_{6-17} = 2,5 V$)	I ₈	-	5,5	-	mA
Input resistance $V_{6-17} > 6 V$	R _i	1,4	2,0	2,6	kΩ
Chrominance amplifier					
Input signal amplitude (note 3)	V _{3-17(p-p)}	55	550	1100	mV
Minimum burst signal amplitude					
within the control range (peak-peak)		30	-	_	mV
Input impedance	Z ₃₋₁₇	_	8,0	_	kΩ
Input capacitance	C ₃₋₁₇	_	4,0	6,0	pF
A.C.C. control range		30	-	_	dB
Change of burst signal at output					
over whole a.c.c. control range		-	-	1	dB
Amplification pin 3 to pin 18 at					
nominal contrast/saturation (note 4)		32	-	_	dB

PARAMETER	SYMBOL	MIN.	TYP.	MAX.	UNIT
Chroma to burst ratio (note 4)		_	3,8	_	dB
Max. output voltage range (pin 18)					
$R_L = 2 k\Omega$		4,0	4,5	-	V
Chrominance amplifier distortion					
at $V_{8-17(p-p)} = 2 V$ (output)					
up to $V_{3-17(p-p)} = 1 V$ (input)	d ₈₋₃	_	3,0	5,0	%
Frequency response between 0 and 5 MHz		_	_	-2	dB
Saturation control range (Fig.3)		50	_	-	dB
Saturation control input current at					
V ₅₋₁₇ < 6 V	I ₅	_	1	20	μA
Input impedance for V5 between					
6 and 10 V	Zi	1,4	2,0	2,6	kΩ
Input impedance when colour					
killer is active	Zi	1,4	2,0	2,6	kΩ
Input impedance for $V_5 > 10 V$					
(adjustment procedure)	Zi	0,7	1,0	1,3	kΩ
Tracking between luminance and chrominance					
over 10 dB of contrast control range		_	_	2	dB
Cross coupling between luminance and					
chrominance amplifiers (note 5)		_	_	-46	dB
Signal-to-noise ratio at nominal input					
signal (note 6)	S/N	56	_	_	dB
Burst phase shift with respect to chrominance					
at nominal contrast/saturation (note 4)	Δφ	_	_	±5	deg
Chrominance amplifier output impedance	Z ₁₈₋₁₇	_	25	-	Ω
Output current (pin 18)	I ₁₈	_	-	10	mA
Reference part					
Phase-locked loop					
Catching range	Δf	500	700	_	Hz
Phase shift for \pm 400 Hz deviation					
of oscillator frequency	Δφ	_	_	5	deg
Oscillator					-
Temperature coefficient of oscillator					
frequency	TCosc	_	2	3	Hz/K
Frequency deviation when supply voltage					
changes from 10 to 13,2 V	Δf _{osc}	_	200	300	Hz

PARAMETER	SYMBOL	MIN.	TYP.	MAX.	UNIT	
Input resistance	R ₁₆₋₁₇	250	290	330	Ω	
Input capacitance	C ₁₆₋₁₇	_	-	10	pF	
A.C.C. generation						
Voltage with nominal input signal	V ₄₋₁₇	-	5,0	-	V	
Voltage without chrominance input	V ₄₋₁₇	-	2,5	-	V	
Colour-off voltage	V ₄₋₁₇	-	3,2	-	V	
Colour-on voltage	V ₄₋₁₇	-	3,5	-	V	
Identification-on voltage	V ₄₋₁₇	-	2,5	-	V	
Pin 2 voltage at nominal input signal	V ₂₋₁₇	-	5,1	-	V	
Demodulator part						
Burst signal amplitude (peak-to-peak value)						
at pins 13 and 14 (note 7)	V _{13-17(p-p)}	_	80	_	mV	
	V _{14-17(p-p)}					
Input impedance of pins 13 or 14 to pin 17	Z _{13, 14-17}	_	1,0	_	kΩ	
Ratios of demodulated signals with equal						
signal inputs to pins 13 and 14 and no luminance input signal:						
(B-Y)/(R-Y)	$\frac{V_{12-17}}{V_{10-17}}$	-	1,78±10%	_		
(G-Y)/(R-Y) (no (B-Y) signal)	$\frac{V_{11-17}}{V_{10-17}}$	_	-0,51±10%	_		
(G–Y)/(B–Y) (no (R–Y) signal)	$V_{11-17} = V_{12-17}$	-	–0,19±10%	_		
Frequency response between 0 and 1 MHz Separation of colour difference		_	_	-3	dB	
channels		40	-	_	dB	
Phase difference between (R-Y) signal						
and (R–Y) reference signal	Δφ	_	_	5	deg	
Phase difference between (R-Y) and						
(B–Y) reference signals	Δφ	85	90	95	deg	
RGB matrix and amplifiers						
Output signal amplitudes (peak-to-peak	V _{10-17(p-p)}					
value) at nominal luminance signal and	V _{11-17(p-p)}	4,5	5,0	5,5	V	
contrast inputs (black-white) (note 4)	V _{12-17(p-p)}					

Product specification

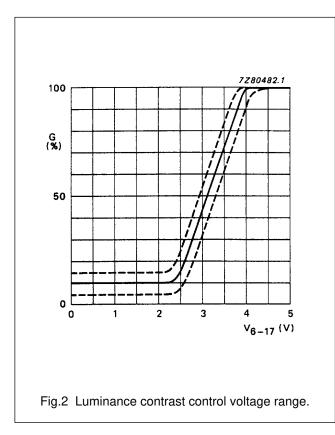
PARAMETER	SYMBOL	MIN.	TYP.	MAX.	UNIT
Red channel output amplitude (peak-to-					
peak value) at nominal contrast/saturation (note 4) and no luminance signal to (R–Y)	V _{10-17(p-p)}	3,7	5,25	7,4	V
Maximum peak white level (note 8)		9,0	9,3	9,6	V
Maximum output current	I _{10,11,12}	_	-	15	mA
Red channel black level output when					
brightness control $V_{9-17} = 2 V$	V ₁₀₋₁₇	_	2,7	-	V
Difference between black levels					
in R, G and B outputs		-	-	600	mV
Black level shift with picture content		_	-	40	mV
Brightness control voltage range	V ₉₋₁₇	see Fig.3	3		
Brightness control input current at					
V ₉₋₁₇ = 2 V	lg	_	-	-50	μA
Variation of black level with temperature		_	+0,35	1,0	mV/K
Variation of black level with contrast					
control		_	10	100	mV
Relative spread between the three channel					
outputs		-	-	10	%
Relative variation in black level between					
the three channels during normal variations of contrast and supply voltage		-	0	20	mV
Differential drift of black level over a					
temperature range of 40 °C		-	0	20	mV
Blanking level at the three channel					
outputs		1,9	2,1	2,3	V
Difference in blanking level of the three					
channel outputs		-	0	-	mV
Differential drift of blanking levels					
over a temperature range of 40 °C		-	0	-	mV
Tracking of output black levels with					
variation of supply voltage	$\frac{\Delta V_{bl}}{V_{bl}} \times \frac{V_{P}}{\Delta V_{P}}$	-	1,1	-	
Signal-to-noise ratio of output signals					
(note 6)	S/N	62	_	_	dB
Residual 4,4 MHz component in output					
signals (peak-to-peak value)		_	25	50	mV
Residual 8,8 MHz and higher harmonic					
components in output signals (peak-to-peak value)		-	25	50	mV
Output impedance	Z _{10,11,12-17}	_	50	_	Ω

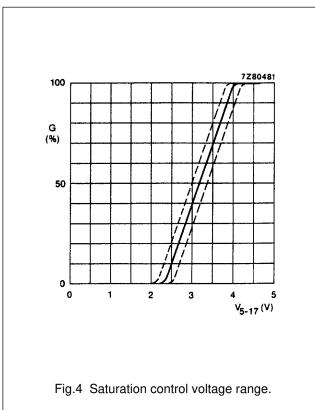
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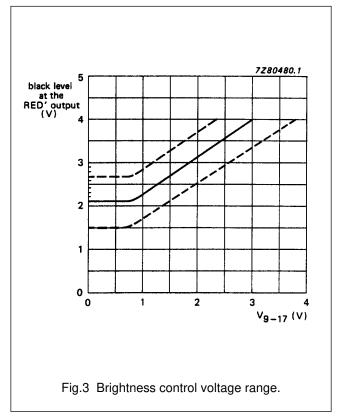
PARAMETER	SYMBOL	MIN.	TYP.	MAX.	UNIT
Frequency response of total luminance/					
RGB amplifier circuits for 0 to 5 MHz		-	-	-3	dB
Sandcastle pulse detector					
Level at which RGB blanking is activated	V ₇₋₁₇	1,0	1,5	2,0	V
Level at which burst gate and clamping					
pulse are separated	V ₇₋₁₇	6,5	7,0	7,5	V
Delay between black level clamping and					
burst gating pulse		-	0,4	_	μs
Input current at:					
$V_{7-17} = 0$ to 1 V	I ₇	-	-	-1	mA
V ₇₋₁₇ = 1 to 8,5 V	I ₇	-	20	40	μA
V ₇₋₁₇ = 8,5 to 12 V	I ₇	-	-	2	mA

Notes to the characteristics

- 1. At nominal contrast and nominal brightness.
- 2. Signal with negative-going sync pulse, amplitude includes sync pulse amplitude.
- 3. The signal indicated is for a colour bar with 75% saturation, so the chroma burst ratio of 2,2 : 1.
- 4. Nominal contrast is defined as (maximum contrast -3 dB) and nominal saturation is (maximum saturation -12 dB).
- 5. Cross coupling is measured under the following condition; input signals nominal and contrast/saturation such that nominal output signals are obtained. The signals at the output at which no signal should be available must be compared with the nominal signal at that output.
- 6. The signal-to-noise ratio is specified as peak-to-peak signal with respect to r.m.s. noise.
- 7. These signal amplitudes are determined by the a.c.c. circuit of the reference part.
- 8. When this level is exceeded the amplitude of the output signal is reduced via a discharge of the capacitor at pin 6 (contrast control). The discharge current is 5,5 mA.

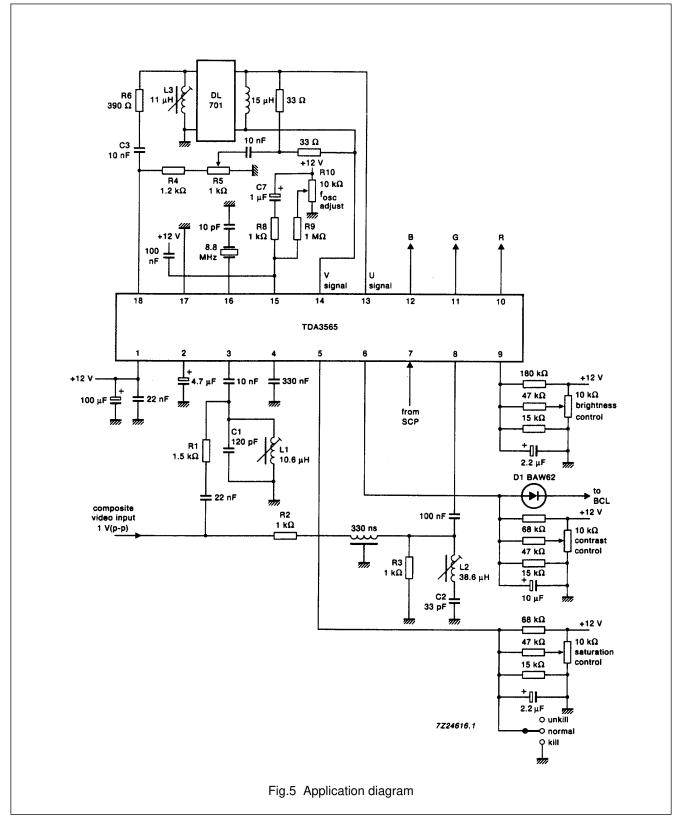






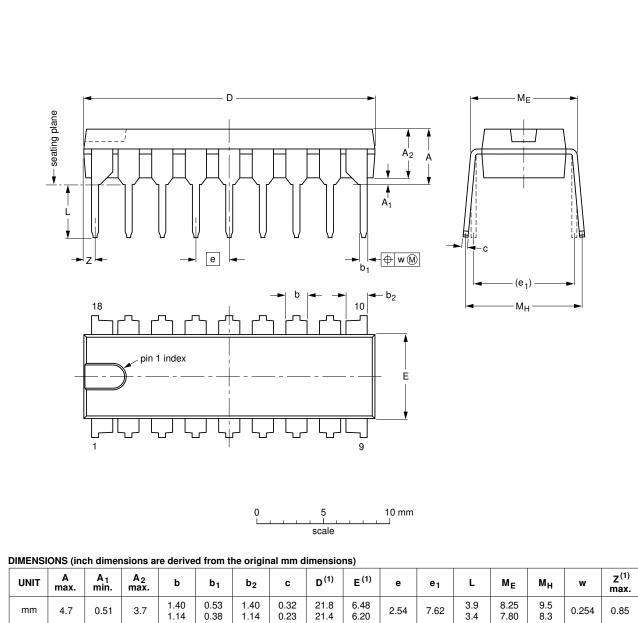
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APPLICATION INFORMATION



PACKAGE OUTLINE

DIP18: plastic dual in-line package; 18 leads (300 mil)



inches 0.19 0.020 0.15 0.055 0.021 0.055 0.041 0.055 0.043 0.068 0.26 0.10 0.30	mm	4.7	0.51	3.7	1.40 1.14	0.53 0.38	1.40 1.14	0.32 0.23	21.8 21.4	6.48 6.20	2.54	7.62
	inches	0.19	0.020	0.15							0.10	0.30

Note

1. Plastic or metal protrusions of 0.25 mm maximum per side are not included.

OUTLINE		REFER			
VERSION	IEC	JEDEC	EIAJ	PROJECTION	ISSUE DATE
SOT102-1					93-10-14 95-01-23

0.15

0.13

0.32

0.31

0.37

0.33

0.01

0.033

TDA3565

SOT102-1

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SOLDERING

Introduction

There is no soldering method that is ideal for all IC packages. Wave soldering is often preferred when through-hole and surface mounted components are mixed on one printed-circuit board. However, wave soldering is not always suitable for surface mounted ICs, or for printed-circuits with high population densities. In these situations reflow soldering is often used.

This text gives a very brief insight to a complex technology. A more in-depth account of soldering ICs can be found in our *"IC Package Databook"* (order code 9398 652 90011).

Soldering by dipping or by wave

The maximum permissible temperature of the solder is 260 °C; solder at this temperature must not be in contact with the joint for more than 5 seconds. The total contact time of successive solder waves must not exceed 5 seconds.

The device may be mounted up to the seating plane, but the temperature of the plastic body must not exceed the specified maximum storage temperature ($T_{stg max}$). If the printed-circuit board has been pre-heated, forced cooling may be necessary immediately after soldering to keep the temperature within the permissible limit.

Repairing soldered joints

Apply a low voltage soldering iron (less than 24 V) to the lead(s) of the package, below the seating plane or not more than 2 mm above it. If the temperature of the soldering iron bit is less than 300 °C it may remain in contact for up to 10 seconds. If the bit temperature is between 300 and 400 °C, contact may be up to 5 seconds.

DEFINITIONS

Data sheet status	
Objective specification	This data sheet contains target or goal specifications for product development.
Preliminary specification	This data sheet contains preliminary data; supplementary data may be published later.
Product specification	This data sheet contains final product specifications.
Limiting values	

Limiting values given are in accordance with the Absolute Maximum Rating System (IEC 134). Stress above one or more of the limiting values may cause permanent damage to the device. These are stress ratings only and operation of the device at these or at any other conditions above those given in the Characteristics sections of the specification is not implied. Exposure to limiting values for extended periods may affect device reliability.

Application information

Where application information is given, it is advisory and does not form part of the specification.

LIFE SUPPORT APPLICATIONS

These products are not designed for use in life support appliances, devices, or systems where malfunction of these products can reasonably be expected to result in personal injury. Philips customers using or selling these products for use in such applications do so at their own risk and agree to fully indemnify Philips for any damages resulting from such improper use or sale.

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Datasheets for electronics components.